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March 2015

FDD86110

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 50 A, 10.2 m $\Omega$

#### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 10.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 12.5 A
- Max  $r_{DS(on)}$  = 16 m $\Omega$  at  $V_{GS}$  = 6 V,  $I_D$  = 9.8 A
- 100% UIL tested
- RoHS Compliant

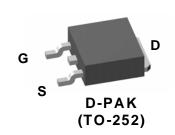


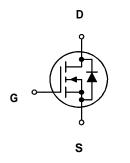
### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

#### Application

DC - DC Conversion





#### **MOSFET Maximum Ratings** $T_C = 25 \degree C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		50		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	12.5	Α	
	-Pulsed		(Note 4)	150		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	135	mJ	
P <sub>D</sub>	Power Dissipation $T_{C} = 25 \text{ °C}$			127	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1	V	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tempera	iture Range		-55 to +150	°C	

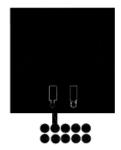
#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.98	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 40	0/10

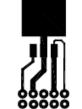
#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86110	FDD86110	D-PAK(TO-252)	13 "	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V	
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature		100				
$\Delta T_{J}$	Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		72		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	2.8	4	V	
ΔV <sub>GS(th)</sub>	Gate to Source Threshold Voltage			10		2400	
$\Delta T_J$	Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C	
	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A		8.5	10.2		
r <sub>DS(on)</sub>		$V_{GS} = 6 V, I_D = 9.8 A$		11.3	11.3 16 mg		
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}, \text{T}_{J} = 125^{\circ}\text{C}$		15	18		
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$		38		S	
C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1MHz		1702 379	2265 505	pF pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			17	30	pF	
R <sub>g</sub>	Gate Resistance		0.1	0.5	1.5	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			12	20	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12.5 A,		5.4	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	35	ns	
t <sub>f</sub>	Fall Time			3.9	10	ns	
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ V <sub>DD</sub> = 50 V,		25	35	nC	
Q <sub>gs</sub>	Gate to Source Charge	$V_{DD} = 50 \text{ V},$ $I_{D} = 12.5 \text{ A}$		7.1		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	10 - 12.0 /		5.2		nC	
Drain-Sou	arce Diode Characteristics						
	Source-Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12.5 A (Note 2)		0.80	1.3	V	
V <sub>SD</sub>		$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.72	1.2		
t <sub>rr</sub>	Reverse Recovery Time			52	83	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 12.5 A, di/dt = 100 A/μs		60	96	nC	



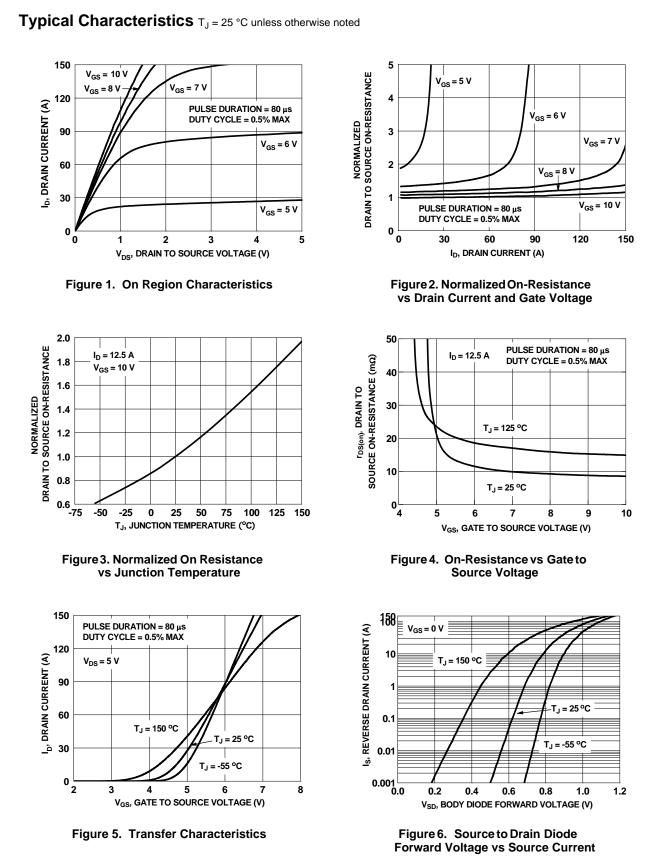
a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

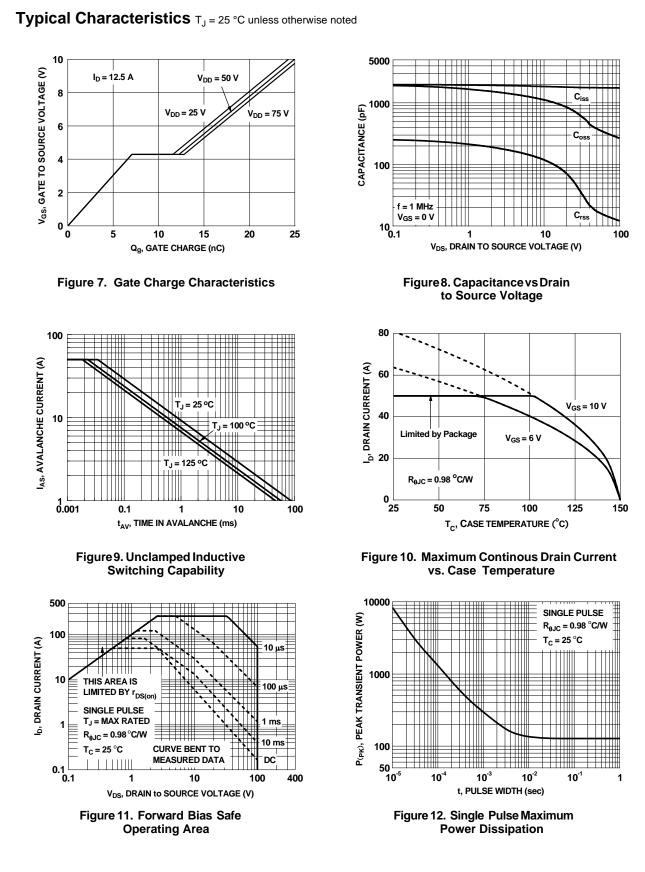


b) 96 °C/W when mounted on a minimum pad

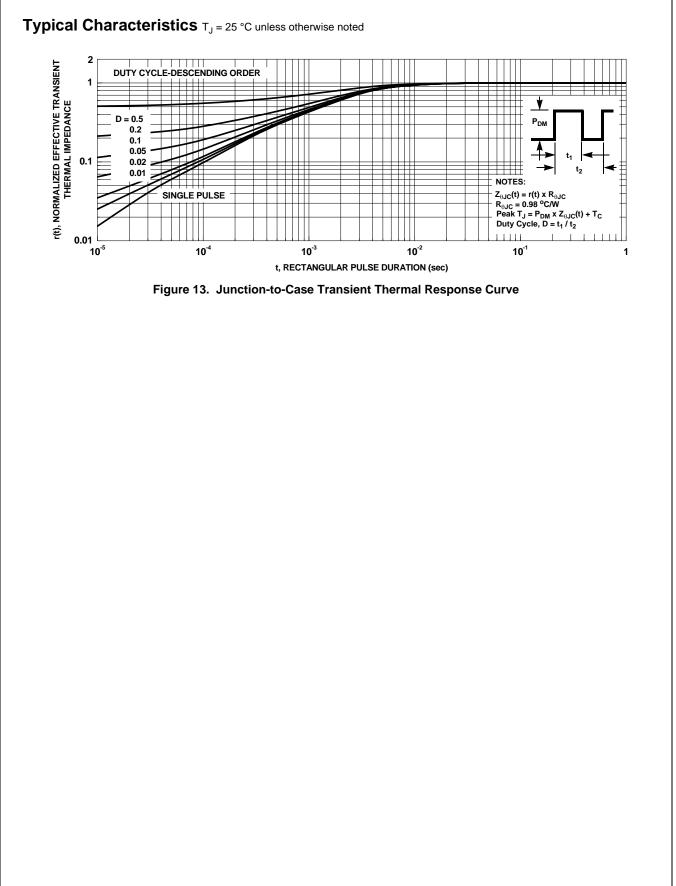
- Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.</li>
   Starting T<sub>J</sub> = 25 °C, L = 0.3 mH, I<sub>AS</sub> = 30 A, V<sub>DD</sub> = 90 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 48 A.
   Pulsed Drain current is tested at 300 µs with 2% duty cycle. For repetitive pulses, the pulse width is limited by the maximum junction temperature.







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FDD86110 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET



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